BOM for BOOSTXL-SENSORS

Do not populate (Dnp) part if Quantity equals zero
Use exact PartNumber and Manufacturer if this data is provided
Feedback from CM needed where supplier equals CM

Q	y Reference	Manufacturer	Description	Part Number	Size	Value	Supplier1	Digikey Number
	C1, C2, C3, C4, C5, C6, C7		CAP CER 0.1UF 10V 20% X7R 0603,Digikey 399-1095-2-ND		603	100n	Digikey	399-1095-2-ND
:	. C8	Standard	CAP CER 10000PF 10V 5% U2J 0603,Digikey 490-8296-2-ND		603	0.01u	Digikey	490-8296-2-ND
:	J1/J3	Standard	M/F CONN HEADER .100 DOUBLE STR 20POS		0.100 inch x 2 x 10		MLE	CRD-081413-G-A
:	J2/J4	Standard	M/F CONN HEADER .100 DOUBLE STR 20POS		0.100 inch x 2 x 10		MLE	CRD-081413-G-A
:	R1, R2	Standard	RES 0.0 OHM 1/8W 0805 SMD,Digikey 311-0.0ARTR-ND		805	0	Digikey	311-0.0ARTR-ND
:	R3, R4	Standard	RES 33 OHM 1/10W 1% 0603 SMD, Digikey 311-33.0HRTR-ND		603	33	Digikey	311-33.0HRTR-ND
:	R5, R6	Standard	RES 2.2K OHM 1/10W 1% 0603 SMD,Digikey 311-2.20KHRTR-ND		603	2.2K	Digikey	311-2.20KHRTR-ND
:	. R7	Standard	RES 10K OHM 1/10W 1% 0603 SMD ,Digikey 311-10.0KHRTR-ND		603	10k	Digikey	311-10.0KHRTR-ND
:	. U1	TI	IC SENSOR AMBIENT LIGHT USON6	OPT3001DNPR			TI	296-40474-2-ND
:	. U2	Bosch	BOSCH SENSORTEC BOARD MOUNT MAGNETIC SENSOR WLCSP-12	BMM150			Mouser	
:	. U3	Bosch	BOSCH SENSORTEC INERTIAL MEASUREMENT UNIT LGA-14	BMI160			Mouser	
:	. U4	Bosch	BOSCH SENSORTEC BOARD MOUNT HUMIDITY SENSOR LGA-8	BME280			Mouser	
	. U5	TI	IC SENSOR THERMOPILE 8DSBGA	TMP007AIYZFR			TI	296-40675-2-ND

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